

Multilayer Ceramic Chip Capacitor

	P + SYFER + VOLTRONICS						
Part Number:	2211JA250681J	KTSYX	Description:	2211 250Vac (Y2), 305Vac (X1), 50/60Hz / 1000Vdc 680pF ±5% C0G/NP0 (1B) to AEC- Q200			
Approval	Approval IEC/EN60384-14:2013+A1			~			
Specifications:							
	Certification: TÜV R60153659 / ID1111233476		<	T			
Certification:				T			
	UL/cUL E228790-20201127			+ 3			
	IEC/EN 60384-14:2013+A1 Class Y2 / X1		\prec				
Classification:			L2- L4 - L3				
	UL/cUL FOWX2, FOWX8			L^2			
			Component				
			Component Marking and Certification Bodies:				
Material Group I : CTI >= 600			SY102 C US US				
Mechanical Specification							
Size Code		moonanou	2211				
Length (L1) in mm (")			5.7 ± 0.40 (0.225 ± 0.016)				
Width (W) in mm (")			2.79 ± 0.30 (0.11 ± 0.012)				
Thickness (T) in mm (Thickness (T) in mm (")			2.54 Max (0.1 Max)			
Minimum Termination	Minimum Termination Band (L2,L3) in mm (")			0.50 (0.020)			
Maximum Termination	Maximum Termination Band (L2,L3) in mm (")			0.80 (0.030)			
Minimum Band Gap (L4) in mm (")			4.0 (0.158)				
Termination Material			Nickel Barrier, Sn Plated Solder (RoHS compliant)				
Solderability	Solderability			IEC-60068-2-58			
Packaging	Packaging			7" Reel Horizontal Orientation, 500 per reel			
	G	eneral Electri	cal Specificati	on			
Rated Voltage			Class Y2 (250Vac), Class X1 (305Vac), 50/60Hz, 5kV impulse				
Humidity Grade	Humidity Grade			Grade III (IEC/EN60384-14:2013 Annex 1)			
Maximum DC Working Voltage			1000Vdc certified / (2500Vdc outside scope of any specification)				
Nominal Capacitance Value			680pF				
Capacitance Tolerand	Capacitance Tolerance			±5%			
Tangent of Loss Angle (Tan δ)			≤0.0015				
Capacitance and Tan δ Test Conditions			1.0Vrms @ 1MHz				
Voltage Proof		100% test: 4000Vdc 1s min / 5s max AOL test: 4000Vdc / 3000Vac 60s min / 5kV/ 1 2x50us impulse					
(50mA max charging current for DC tests)		AQL test: 4000Vdc / 3000Vac 60s min / 5kV 1.2x50µs impulse					
Min Insulation Resistance (IR)		100.00GOhm @ 100Vdc C0G/NP0 (1B) to AEC-Q200					
Dielectric Classification			-55°C / +125°C				
Rated Temperature Range			No DC Voltage 0±30ppm/°C				
Maximum Capacitance Change over Temperature Range			Rated DC Voltage -				
Climatic Category (IEC)			55/125/56	55/125/56			
Ageing Characteristic			Zero				
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Environmental							
RoHS Compliant to 2011/65/EC as amended by 2015/863/EU Compliant							
REACH Compliant		211 compliant					
California Proposition 65		No exposure risk					
Board Layout							
Knowles' conventional 2-terminal chip generally be mounted using pad designs i international specification IPC-7351, Gene for Surface Mount Design and Land Patter there are some other factors that have bee mechanical stress, such as reducing the than the chip width. In addition, the position board should be considered. Some high voltage parts may require me board layout and/or the addition of a con prevent flashover. Refer to application further information.	n accordance with eric Requirements ern Standards, but n shown to reduce pad width to less n of the chip on the odifications to the nformal coating to note AN0043 for Pack	kaging	IPC-7351 pad design 2211 C 5.40mm 0.213" Y 1.35mm 0.053" X 3.10mm 0.122" I I I x I I y I I y I I y I I y I I y I I y I I y I I y I I y I I y I I y I I y I I y I I y I I y I I y I I y I I y I I y I I y I I y I I y I I y I I<				
Tape and reel packing of surface moun capacitors for automatic placement are with IEC60286-3.	ting chip		Top tape 8 or 12mm 178mm (7") or nominal 330mm (13") dia. reel				
Soldering							
Reflow solder in accordance with IPC-/ Recommended reflow profile as laid do IPC/JEDEC J-STD-020. Wave soldering is also possible, but ca taken for case sizes 1210 and larger an thickness >1.0mm. Trials are encourage Hand soldering is not recommended ar component damage through thermal sh	own in Ire must be nd component jed. nd can lead to	Temperature	Max Min t t ts TL TL TL TL TL TL TL TL TL TL TL TL TL				
Application notes with mounting and handling guidance are available on request.							
Compex DLI .	Johanson MFG	Novacap	Syfer Voltronics				
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